

AMP-METRIMATE

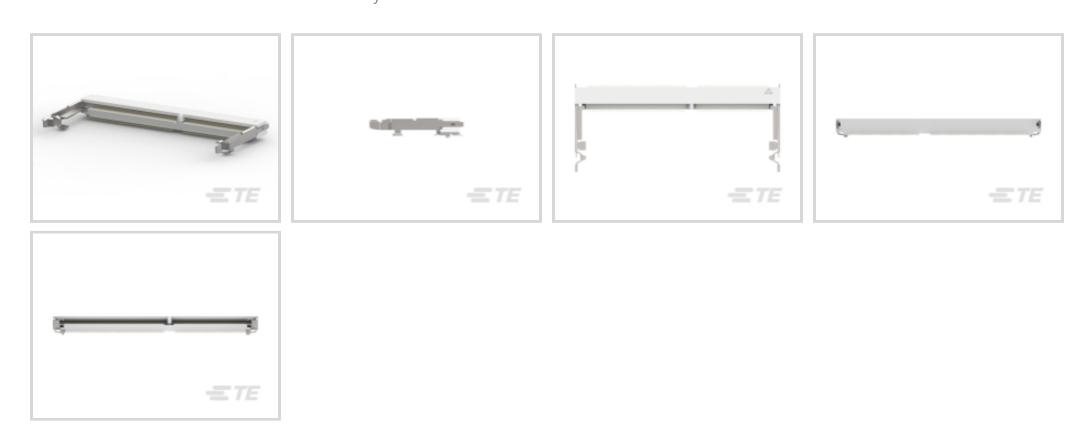
TE Internal #: 390113-1

SO DIMM Sockets, Small Outline (SO), Stack Height .205 in [5.2 mm], Right Angle Module Orientation, Surface Mount Mount, Cable-to-Board, AMP-METRIMATE

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Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR3 SO DIMM Sockets



DRAM Type: Small Outline (SO) Stack Height: **5.2 mm [.205 in]** Module Orientation: Right Angle PCB Mounting Style: Surface Mount Connector System: Cable-to-Board

All DDR3 SO DIMM Sockets (12)

Features

Product Type Features

DRAM Type	Small Outline (SO)
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Socket
Configuration Features	

Number of Bays	2
Center Key	Offset Left
Number of Keys	1
Module Orientation	Right Angle
Number of Positions	144
Number of Rows	2



Electrical Characteristics

Electrical Characteristics	
DRAM Voltage	3.3 V
Body Features	
Ejector Location	None
Latch Material	Stainless Steel
Latch Plating Material	Tin
Module Key Type	SDRAM
Connector Profile	Standard
Contact Features	
Socket Style	SO DIMM
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.25 μm[9.84 μin]
Socket Type	Memory Card
Termination Features	
Insertion Style	Cam-In
Mechanical Attachment	
PCB Mount Retention	With
PCB Mount Retention Type	Hold-Down Post
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Housing Color	Natural
Housing Material	High Temperature Plastic
Dimensions	
Stack Height	5.2 mm[.205 in]

Usage Conditions

Row-to-Row Spacing

Operating Temperature Range -55 – 105 °C[-67 – 221 °F]

6.2 mm[.244 in]

Operation/Application



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Soft Tray
Packaging Quantity	20

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

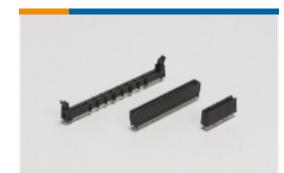
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

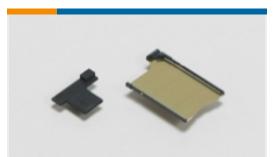




Also in the Series | AMP-METRIMATE



Card Edge Power Connectors(1)



Card Guide Hardware(1)



PCB Headers & Receptacles(3)



Rack & Panel Connectors(1)



Rectangular Power Connectors(9)



RJ45 Connectors(51)



SO DIMM Sockets(12)

Customers Also Bought



TE Part #1892787-6 Assy Vert MINIPAK HDL Rcpt 25s



TE Part #2149730-1 SFP+ 1x4 Cage, Heatsinks and Lightpipes



TE Part #5223986-3
UPM KEYED GUIDE MODULE





TE Part #61174-5 CMNL PIN L/P AUNIBR



TE Part #6-1624108-3 3640 0402 7.2nH +/-0.2nH 1K RL



TE Part #D98213-000 T1K-165051-25-9





TE Part #1-2198230-4 SFP+ Enhanced 1x2, Networking Heatsink

Documents

Product Drawings

SKT,SODIMM,144P,SDRAM3.3V,STD,TY-S

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_390113-1_H.2d_dxf.zip

English

Customer View Model

ENG_CVM_390113-1_H.3d_igs.zip

English

Customer View Model

ENG_CVM_390113-1_H.3d_stp.zip

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English

Agency Approvals

Agency Approval Document

English